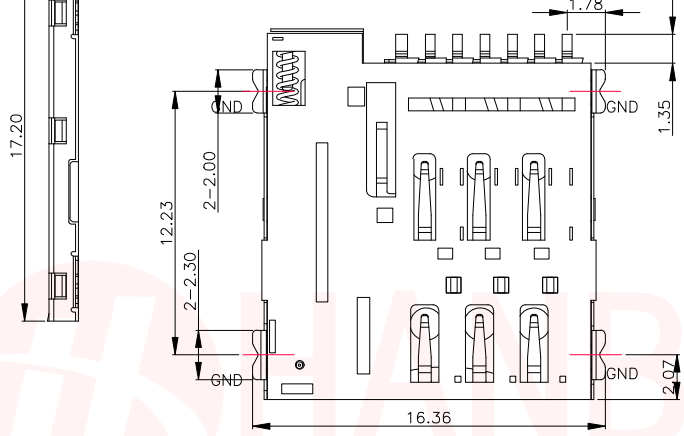
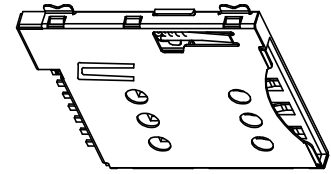
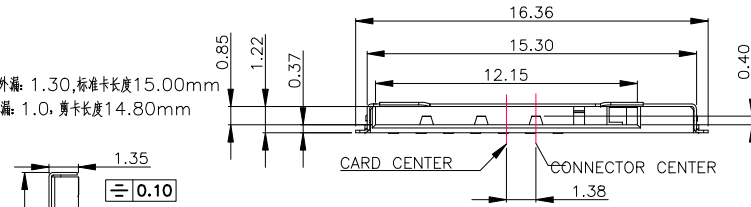
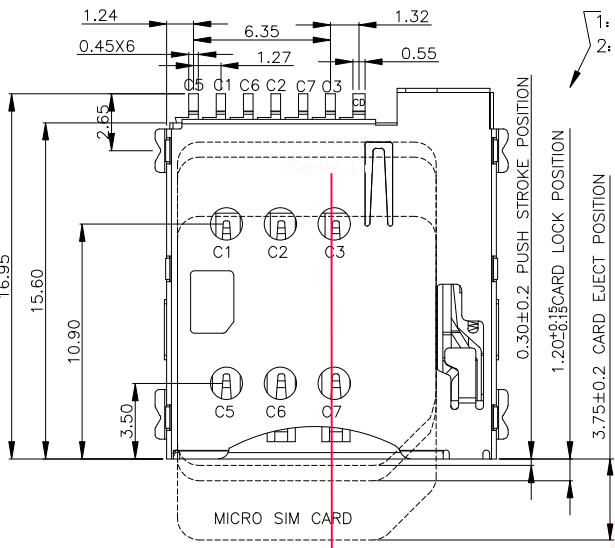




REV.	ECN NO OR DESCRIPTION	REVISED	DATE



### Specification

#### MATERIAL:

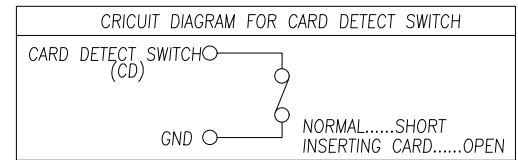
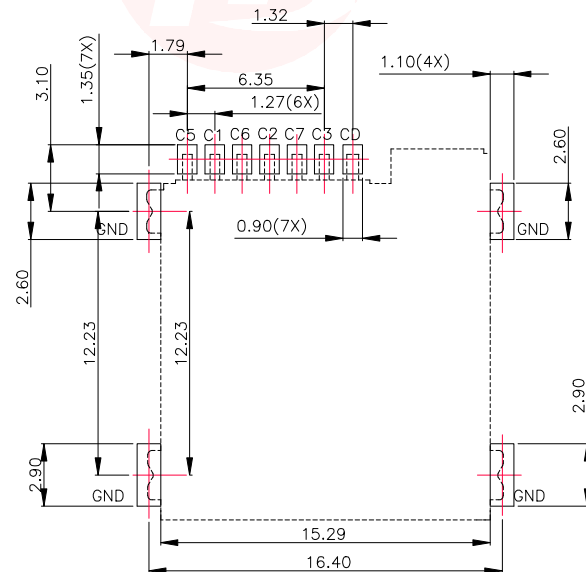
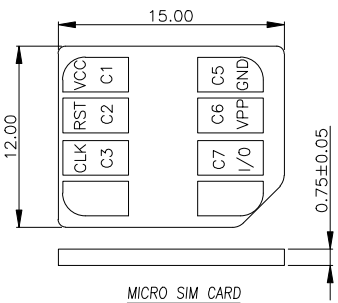
Insulator: High Temperature Thermoplastic, UL 94V-0.  
Contact: Copper Alloy  
SHELL: SUS

#### PLATING:

Contact: Plated 50u" Ni Over all Contact Au 1U  
Shell: Plated 50u" Ni Overall  
Plated 1u"Au Selective Contact Area

#### Electrical:

Current Rating :0.5mA  
Voltage Rating :5V AC/DC  
Ambient Temperature Range :-20°C~+60°C  
Storage Temperature Range :-40°C~+85°C  
Ambient Humidity Range :95% R.H. Max.  
Contact Resistance:100m Ω max.  
Insulation Resistance:1000M Ω min./500VDC  
产品耐温温度: 260°C <math>T\_c < 1.70 > T\_c < 1.70 > +5 < /math>°C  
Mating Cycles:1500Min Insertions



SIM pin assignment	
PIN#	Name
C1	VCC供电电压
C2	RST重置
C3	CLK时钟
C5	GND接地
C6	VPP程序电压
C7	I/O输入输出

RECOMMENDED PCB LAYOUT  
GENERAL TOLERANCE ±0.05

UNLESS OTHERWISE SPECIFIED TOLERANCES		东莞市汉博电子科技有限公司 DONGGUAN HANBO TECHNOLOGY CO., LTD	
DECIMALS:	ANGLES:	TITLE	7pin H1.35 push push micro sim card
X :±0.15	X :±2°	DWN	xiong PART NO. SMO-200-P7
X.X :±0.10	X.X :±1°	CHKD	lee SCALE:1:1 UNIT: mm
X.XX :±0.05		APVD	wang SIZE: A4 SHEET:10F 1 REV: A4
CUSTOMER COPY			